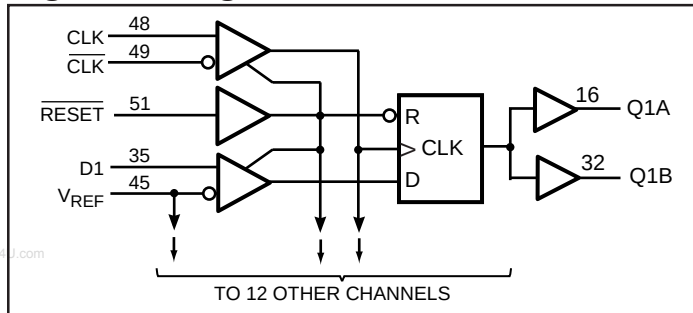


13-Bit to 26-Bit Registered Buffer

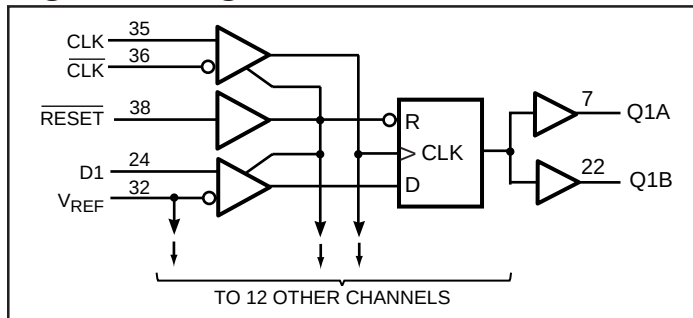
Product Features

- PI74 SSTVF16859 is designed for low-voltage operation, 2.5V for PC1600~PC2700; 2.6V for PC3200
- Supports SSTL_2 Class I specifications on outputs
- All Inputs are SSTL_2 Compatible, except $\overline{\text{RESET}}$ which is LVC MOS.
- Designed for DDR Memory
- Flow-Through Architecture
- Packages:
64-pin, 240-mil wide plastic TSSOP (A)
56-pin, Plastic Very Thin Fine Pitch Quad Flat
No Lead QFN (ZB)

Logic Block Diagram - TSSOP



Logic Block Diagram - QFN



Product Pin Description

Pin Name	Description
$\overline{\text{RESET}}$	Reset (Active Low) LVC MOS
CLK	Clock Input, Positive Differential Input
$\overline{\text{CLK}}$	Clock Input, Negative Differential Input
D	Data Input, D1-D13
Q	Data Output, Q1-Q13
GND	Ground
V _{DD}	Core Supply Voltage
V _{DDQ}	Output Supply Voltage
V _{REF}	Input Reference Voltage

Product Description

Pericom Semiconductor's PI74SSTVF16859 logic circuit is produced using the Company's advanced sub-micron CMOS technology, achieving industry leading speed.

All inputs are compatible with the JEDEC standard for SSTL_2, except the LVC MOS reset ($\overline{\text{RESET}}$) input. All outputs are SSTL_2, Class II compatible.

The device operates from a differential clock (CLK and $\overline{\text{CLK}}$). Data registered at the crossing of CLK going HIGH, and $\overline{\text{CLK}}$ going LOW.

The PI74SSTVF16859 supports low-power standby operation. When $\overline{\text{RESET}}$ is LOW, the differential input receivers are disabled, and undriven (floating) data, clock and reference voltage (V_{REF}) inputs are allowed. In addition, when $\overline{\text{RESET}}$ is LOW, all registers are reset, and all outputs are forced LOW. The LVC MOS $\overline{\text{RESET}}$ input must always be held at a valid logic HIGH or LOW level.

To ensure defined outputs from the register before a stable clock has been supplied, $\overline{\text{RESET}}$ must be held in the LOW state during power up.

In the DDR DIMM application, $\overline{\text{RESET}}$ is specified to be completely asynchronous with respect to CLK and $\overline{\text{CLK}}$. Therefore, no timing relationship can be guaranteed between the two. When entering $\overline{\text{RESET}}$, the register will be cleared and the outputs will be driven LOW quickly, relative to the time to disable the differential input receivers, thus ensuring no glitches on the output. However, when coming out of $\overline{\text{RESET}}$, the register will become active quickly, relative to the time to enable the differential input receivers. When the data inputs are LOW, and the clock is stable, during the time from the LOW-to-HIGH transition of $\overline{\text{RESET}}$ until the input receivers are fully enabled, the design must ensure that the outputs will remain LOW.

Pericom's PI74SSTVF16859 is characterized for operation from 0°C to 70°C.

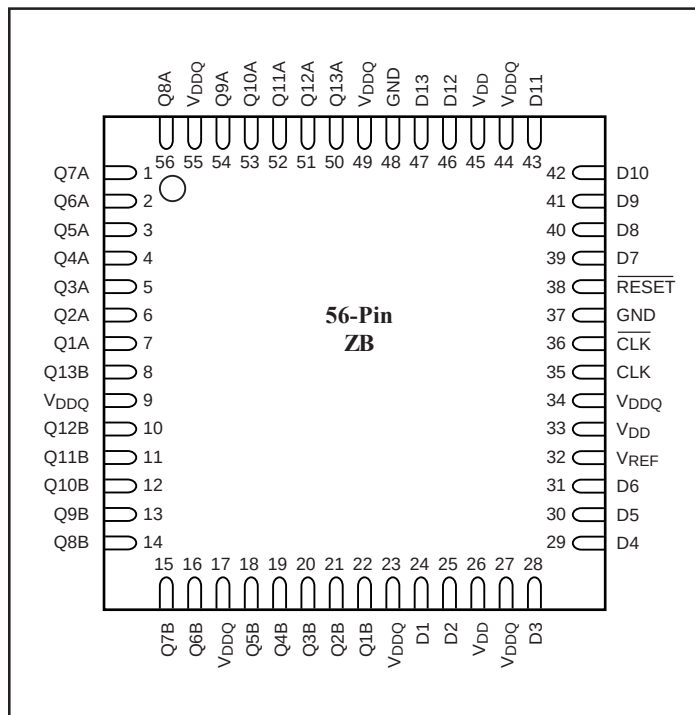
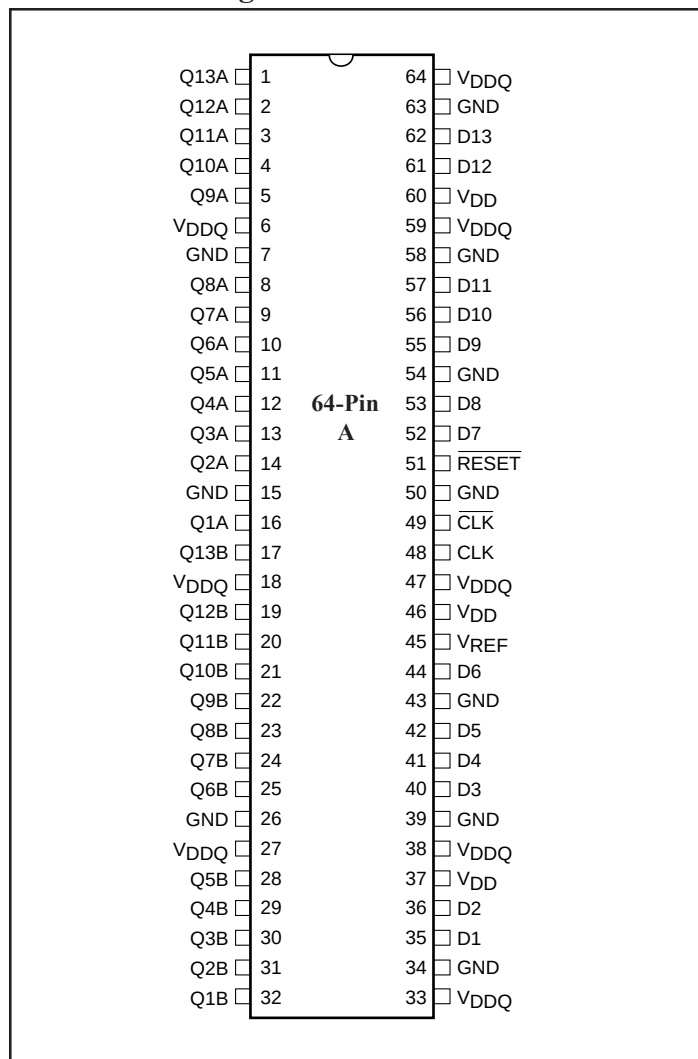
Truth Table⁽¹⁾

Inputs				Outputs
$\overline{\text{RESET}}$	CLK	$\overline{\text{CLK}}$	D	Q
L	X or Floating	X or Floating	X or Floating	L
H	↑	↓	H	H
H	↑	↓	L	L
H	L or H	L or H	X	Q ₀ ⁽²⁾

Notes:

- H = High Signal Level
L = Low Signal Level
↑ = Transition LOW-to-HIGH
↓ = Transition HIGH-to-LOW
X = Irrelevant or floating
- Output level before the indicated steady state input conditions were established.

Product Pin Configurations



Maximum Ratings (Above which the useful life may be impaired. For user guidelines, not tested.)

Item	Symbol/ Conditions	Ratings	Units
Storage Temperature	T_{stg}	-65 to 150	°C
Supply Voltage	V_{DD} or V_{DDQ}	-0.5 to 3.6	V
Input Voltage ^(1,2)	V_I	-0.5 to $V_{DD} + 0.5$	
Output Voltage ^(1,2)	V_O	-0.5 to $V_{DDQ} + 0.5$	
Input Clamp Current	$I_{IK}, V_I < 0$ or $V_I > V_{DD}$	±50	mA
Output Clamp Current	$I_{OK}, V_O < 0$ or $V_O > V_{DDQ}$	±50	
Continuous Output Current	$I_O, V_O = 0$ to V_{DDQ}	±50	
V_{DD}, V_{DDQ} or GND Current/Pin	I_{DD}, I_{DDQ} or I_{GND}	±100	
Package Thermal impedance ⁽³⁾ A Package	ΘJ_A	55	°C/W
2 B-Package		24	

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

1. The input and output negative voltage ratings may be excluded if the input and output clamp ratings are observed.
2. This value is limited to 3.6V Maximum.
3. The package thermal impedance is calculated in accordance with JESD 51.

Recommended Operating Conditions⁽⁴⁾

Parameters	Description		Min.	Nom.	Max.	Units
V _{DD} /V _{DDQ}	Core Output Supply Voltage	PC1600 PC2700	2.3	2.5	2.7	V
	I/O Supply Voltage	PC3200	2.5	2.6	2.7	
V _{REF}	Reference Voltage V _{REF} = 0.5X V _{DDQ}	PC1600 PC2700	1.15	1.25	1.35	
		PC3200	1.25	1.3	1.35	
V _{TT}	Termination Voltage		V _{REF} −0.04	V _{REF}	V _{REF} +0.04	
V _I	Input Voltage		0		V _{DD}	
V _{IH}	AC High -Level Input Voltage	Data Inputs	V _{REF} +310mV			
V _{IL}	AC Low -Level Input Voltage				V _{REF} − 310mV	
V _{IH}	DC High -Level Input Voltage		V _{REF} +150mV			
V _{IL}	DC Low -Level Input Voltage				V _{REF} −150mV	
V _{IH}	High -Level Input Voltage	$\overline{\text{RESET}}$	1.7			
V _{IL}	Low -Level Input Voltage				0.7	
V _{ICR}	Common-mode input range	CLK, $\overline{\text{CLK}}$	0.97		1.53	
V _{ID}	Differential Input Voltage		0.36			
I _{OH}	High-Level Output Current				−16	mA
I _{OL}	Low-Level Output Current				16	
T _A	Operating Free-Air Temperature		0		70	°C

Note:

4. The $\overline{\text{RESET}}$ input of the device must be held at V_{DD} or GND to ensure proper device operation. The differential inputs must not be floating, unless $\overline{\text{RESET}}$ is LOW.

DC Electrical Characteristics for PC1600~PC2700

(Over the Operating Range, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{DD} = 2.5\text{V} \pm 200\text{mV}$, $V_{DDQ} = 2.5\text{V} \pm 200\text{mV}$)

Parameters		Test Conditions	V_{DD}	Min.	Typ.	Max.	Units
V_{IK}		$I_I = -18\text{mA}$	2.3V			- 1.2	V
V_{OH}		$I_{OH} = -100\mu\text{A}$	2.3V- 2.7V	$V_{DD} - 0.2$			
		$I_{OH} = -8\text{mA}$	2.3V	1.95			
V_{OL}		$I_{OL} = 100\mu\text{A}$	2.3V- 2.7V			0.2	
		$I_{OH} = 8\text{mA}$	2.3V			0.35	
I_I	All Inputs	$V_I = V_{DD}$ or GND	2.7V			± 5	μA
I_{DD}	Standby (Static)	$\overline{\text{RESET}} = \text{GND}$	2.7V			10	mA
	Operating (Static)	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$				25	
I_{DDD}	Dynamic Operating clock only	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle			30		$\mu\text{A}/$ clock MHz
	Dynamic Operating per each data input	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle			10		$\mu\text{A}/$ clock MHz data input
C_I	Data Inputs	$V_I = V_{REF} \pm 310\text{mV}$	2.5V	2.5		3.5	pF
	CLK and $\overline{\text{CLK}}$	$V_{ICR} = 1.25\text{V}$, $V_{I(\text{PP})} = 360\text{mV}$					
	$\overline{\text{RESET}}$	$V_I = V_{DD}$ or GND		2.5		3.5	

DC Electrical Characteristics for PC3200

(Over the Operating Range, $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{DD} = 2.6\text{V} \pm 100\text{mV}$, $V_{DDQ} = 2.6\text{V} \pm 100\text{mV}$)

Parameters		Test Conditions	V_{DD}	Min.	Typ.	Max.	Units
V_{IK}		$I_I = -18\text{mA}$	2.5V			- 1.2	V
V_{OH}		$I_{OH} = -100\mu\text{A}$	2.5V- 2.7V	$V_{DD} - 0.2$			
		$I_{OH} = -8\text{mA}$	2.5V	1.95			
V_{OL}		$I_{OL} = 100\mu\text{A}$	2.5V- 2.7V			0.2	
		$I_{OH} = 8\text{mA}$	2.5V			0.35	
I_I	All Inputs	$V_I = V_{DD}$ or GND	2.7V			± 5	μA
I_{DD}	Standby (Static)	$\overline{\text{RESET}} = \text{GND}$	2.7V			10	
	Operating (Static)	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$				25	mA
I_{DDD}	Dynamic Operating clock only	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle			30		$\mu\text{A}/$ clock MHz
	Dynamic Operating per each data input	$\overline{\text{RESET}} = V_{DD}$ $V_I = V_{IH}(\text{AC})$ or $V_{IL}(\text{AC})$ CLK and $\overline{\text{CLK}}$ switching 50% duty cycle. One data input switching at half clock frequency, 50% duty cycle			10		$\mu\text{A}/$ clock MHz data input
C_I	Data Inputs	$V_I = V_{REF} \pm 310\text{mV}$	2.6V	2.5		3.5	pF
	CLK and $\overline{\text{CLK}}$	$V_{ICR} = 1.25\text{V}$, $V_{I(\text{PP})} = 360\text{mV}$					
	$\overline{\text{RESET}}$	$V_I = V_{DD}$ or GND		2.5		3.5	

Timing Requirements (over recommended operating free-air temperature range, unless otherwise noted)

			V _{DD} =2.5V ±0.2V		V _{DD} =2.6V ±0.1V		Units
			Min.	Max.	Min.	Max.	
f _{clock}	Clock Frequency			270		270	MHz
t _w	Pulse Duration, CLK, CLK High or Low		2.5		2.5		ns
t _{act}	Differential inputs active time, data inputs must be low after RESET High			22		22	
t _{inact}	Differential Inputs inactive time, data and clock inputs must be held at valid levels (not floating) after RESET Low					22	
t _{su}	Setup time, fast slew rate ^(5,7)	Data before CK↑, $\overline{\text{CK}}\downarrow$	0.75		0.75		
	Setup time, slow slew rate ^(6,7)		0.9		0.9		
t _h	Hold time, fast slew rate ^(5,7)	Data before CK↑, $\overline{\text{CK}}\downarrow$	0.75		0.75		
	Hold time, slow slew rate ^(6,7)		0.9		0.9		

Notes:

5. Data signal input slew rate ≥ 1 V/ns
6. Data signal input slew rate ≥ 0.5 V/ns and < 1 V/ns
7. CLK, $\overline{\text{CLK}}$ input slew rates are ≥ 1 V/ns.

Switching Characteristics for PC1600~PC2700

(over recommended operating free-air temperature range, unless otherwise noted.)

(See test circuits and switching waveforms).

Parameter	From (Input)	To (Output)	V _{DD} = 2.5V ±0.2V			Units
			Min.	Typ.	Max.	
f _{max}			210			MHz
t _{pd}	CLK, $\overline{\text{CLK}}$	Q	1.1		2.2	ns
t _{phl}	$\overline{\text{RESET}}$	Q			5.0	

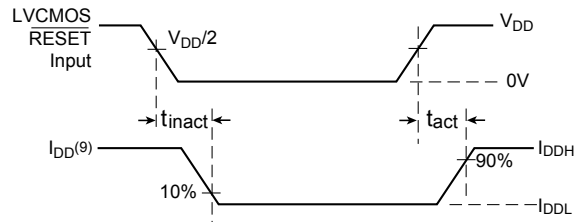
Switching Characteristics for PC3200

(over recommended operating free-air temperature range, unless otherwise noted.)

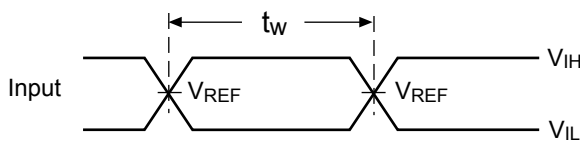
(See test circuits and switching waveforms).

Parameter	From (Input)	To (Output)	V _{DD} = 2.6V ±0.1V			Units
			Min.	Typ.	Max.	
f _{max}			210			MHz
t _{pd}	CLK, $\overline{\text{CLK}}$	Q	1.1		2.2	ns
t _{phl}	$\overline{\text{RESET}}$	Q			5.0	

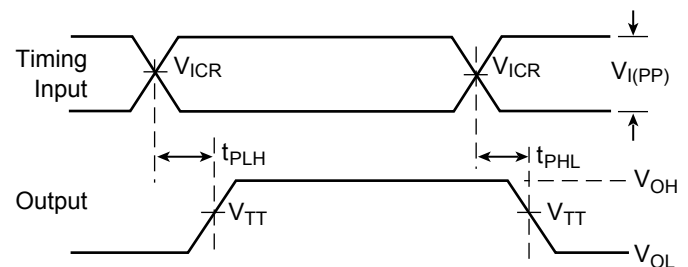
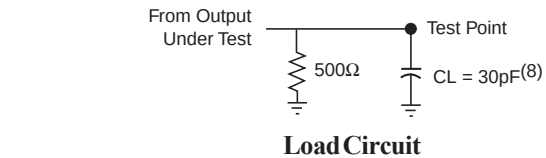
Test Circuit and Switching Waveforms



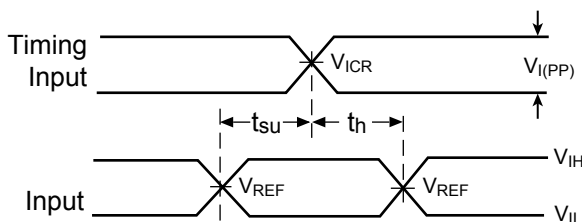
Voltage and Current Waveforms
Input Active and Inactive Times



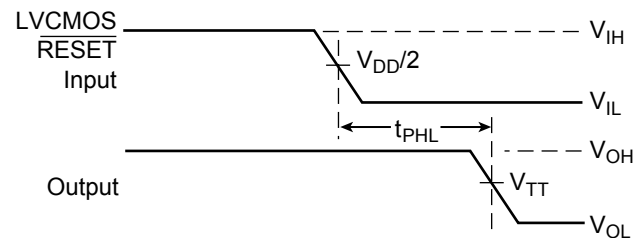
Voltage Waveforms - Pulse Duration



Voltage Waveforms - Propagation Delay Times



Voltage Waveforms - Setup and Hold Times



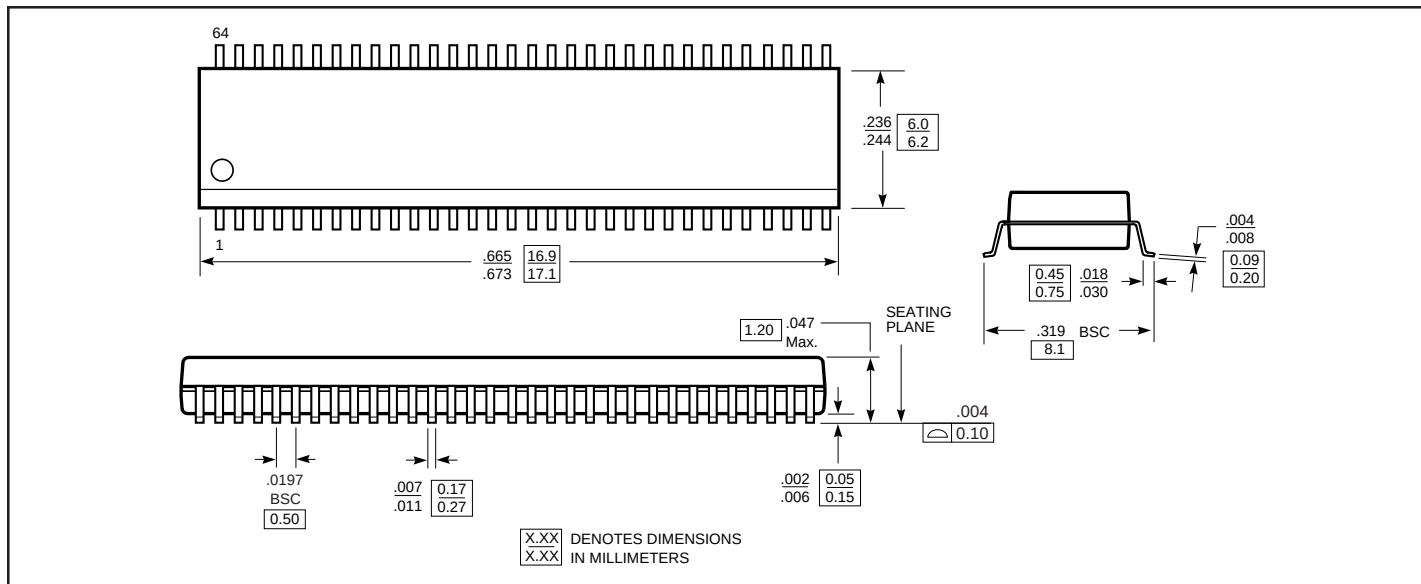
Voltage Waveforms - Propagation Delay Times

Parameter Measurement Information

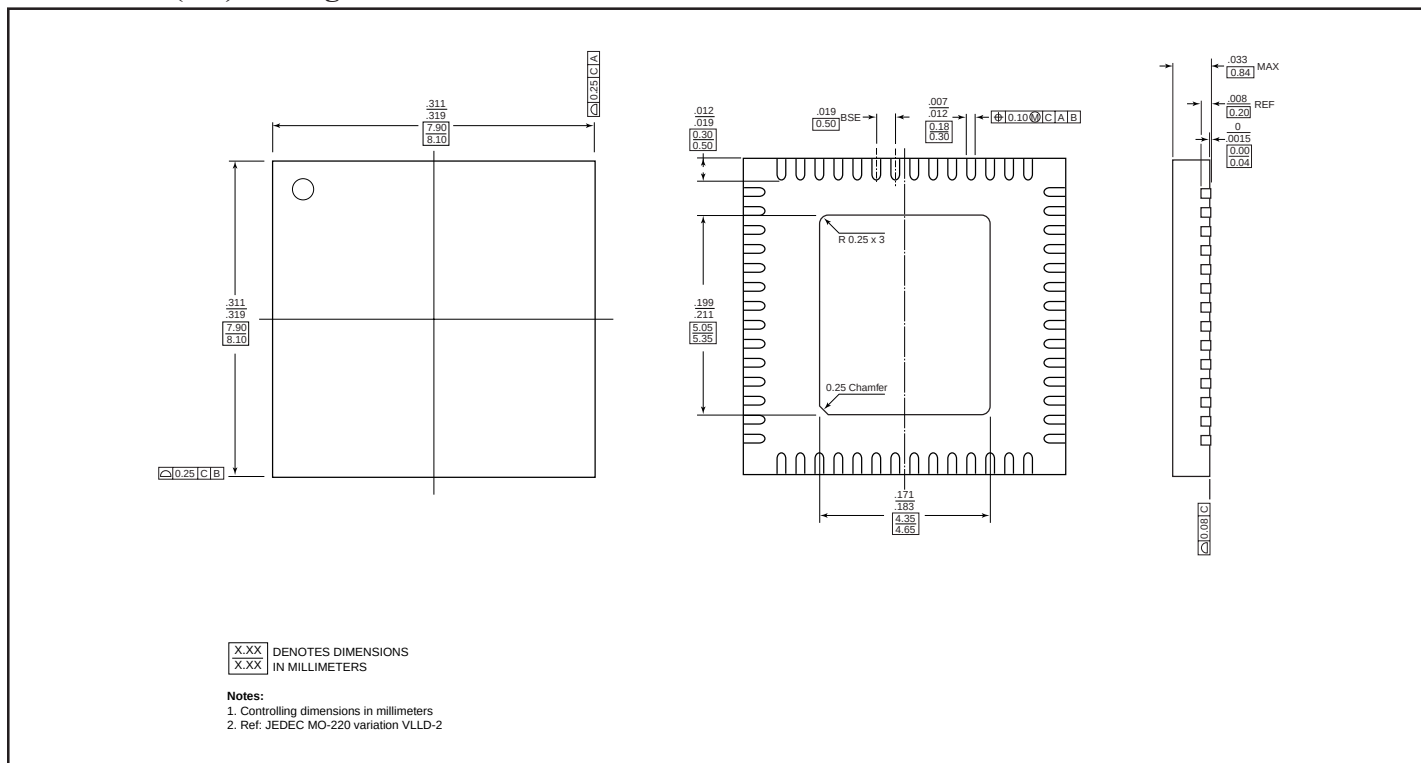
Notes:

8. C_L includes probe and jig capacitance.
9. I_{DD} tested with clock and data inputs held at V_{DD} or GND, and $I_O = 0\text{mA}$.
10. All input pulses are supplied by generators having the following characteristics: $\text{PRR} \leq 10\text{ MHz}$, $Z_O = 50\text{ ohms}$.
 Input slew rate = $1\text{ V/ns} \pm 20\%$ (unless otherwise specified).
11. The outputs are measured one at a time with one transition per measurement.
12. $V_{TT} = V_{REF} = V_{DDQ}/2$
13. $V_{IH} = V_{REF} + 310\text{mV}$ (ac voltage levels) for SSTL inputs. $V_{IH} = V_{DD}$ for LVC MOS input.
14. $V_{IL} = V_{REF} - 310\text{mV}$ (ac voltage levels) for SSTL inputs. $V_{IL} = \text{GND}$ for LVC MOS input.
15. t_{PLH} and t_{PHL} are the same as t_{pd} .

64-Pin TSSOP (A) Package



56-Pin QFN (ZB) Package



Ordering Information

Ordering Code	Package Type	Temperature Range
PI74SSTVF16859A	64-Pin TSSOP	0°C to 70°C
PI74SSTVF16859ZB	56-Pin QFN	

Pericom Semiconductor Corporation

2380 Bering Drive • San Jose, CA 95131 • 1-800-435-2336 • Fax (408) 435-1100 • <http://www.pericom.com>